IPC ASSOCIATION CONNECTED ELECTRONICS INDUST	© Copyright 2005. IF	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard  Form Typ  http://www.ipc.org/IPC-175x  Form Typ  Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						als and Mf	g Inform	nation		
Supplier Info	rmation															
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*				
nsemi													2023-06-08			
Contact Name		Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Ste	ewards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com					
Authorized Repro	esentative*	Title - Representative			I	Phone - Representative*				Email - Representative*						
Product-Env-Ste	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Reque	ester Item Number	Item Number Mfr Item Number FT3001UMX		Item Number Mfr Item Name			Effective Dat	te Versio	sion Manufacturing Site		W	Weight* UOM		Unit Type		
				3s Reset Timer			2023-06-08	06-08 TH2			3.575 mg		Each			
<b>Ianufacturin</b>	ng Proccess Informat	ion														
Termin	nal Plating / Grid Array Ma	terial '	Terminal Base Alloy		J-STD-020 MS	L Rating Peak P		cess Body	ess Body Temperature   Max Time at		me at Peak	ak Temperature Num		umber of Reflow Cycles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		C		30 seco		s <b>3</b>			
Comments										·						
vel 1 - maximun	n time at peak temperatu	re during so	oldering is 10-3	0 seconds		·	·					·				
or more informa	ation regarding material (	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.459	mg	Supplier	Silicon (Si)	7440-21-3		0.459	mg
Die Attach Epoxy	0.116	mg		Epoxy resin	proprietary data		0.0348	mg
			Supplier	Diethylene glycol monoethyl ether acetate	112-15-2		0.0406	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0406	mg
Lead Frame	0.932	mg	Supplier	Zinc (Zn)	7440-66-6		0.001	mg
			Supplier	Iron (Fe)	7439-89-6		0.022	mg
			Supplier	Copper (Cu)	7440-50-8		0.908	mg
			Supplier	Phosphorus (P)	7723-14-0		0.001	mg
Mold Compound-Black	1.98	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.396	mg
			Supplier	Carbon Black (C)	1333-86-4		0.02	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.465	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.099	mg
Plating	0.041	mg	Supplier	Palladium (Pd)	7440-05-3		0.004	mg
			В	Nickel (Ni)	7440-02-0		0.036	mg
			Supplier	Gold (Au)	7440-57-5		0.001	mg
Wire Bond - Au	0.047	mg	Supplier	Gold (Au)	7440-57-5		0.047	mg